Call for the first Application 2024 (Study from June 2024~)

International Exchange Program (Outbound) of the Engineering Schools

We are pleased to announce that a call for the first Applications 2024, the **International Exchange Program** (Outbound) of the Engineering Schools, is now open.

Program Overview

International Exchange Program is a research study abroad program for graduate students of the school of Engineering, the school of Materials and Chemical Technology, and the school of Environment and Society. This program allows students to study abroad at world-class universities with campuses in various countries that have interdepartmental or institution-wide agreements or that are deemed necessary by the Engineering schools. Students are sent to the host institution's laboratory to conduct research. We believe that this experience will help you develop skills and mutual understanding in your field of study, which is necessary for future global researchers. Master's and doctoral students who wish to work globally in the future are encouraged to apply. Students selected through a screening process will receive partial support for study abroad expenses.

Before applying, students must read through the website and comply with the guidelines.

1. Program Open for Application:

Program name	Partner universities				
SERP (C1)	University of Cambridge				
	University of Oxford				
	University of Warwick				
	University of Southampton				
	École polytechnique				
	Sorbonne University				
	Universidad Politécnica de Madrid (UPM)				
	RWTH Aachen University				
	University of Wisconsin-Madison				
	UC Santa Barbara				
	Karlstad University				
	The University of the Basque Country				
AOTULE (C2-a)	The University of Melbourne				
	Tinghua University				
	National Taiwa University				
	The Hong Kong University of Science and Technology				
	Institut Teknologi Bandung				
	Korea Advanced Institute of Science and Technology				
	Maraya University				
	Indian Institute of Technology, Madras				
	Hanoi University of Science and Technology				
	Nanyang Technological University				
	Chulalongkorn University				
	University of Moratuwa				
AOSU (C2-b)	Wuhan University of Technology				
	National Cheng Kung Unviersity				
	Thammasat University				
	Singapore University of Technology & Design				
	National Taiwan University of Science & Technology				
	Chiang Mai University				
(C3-a)	University that has an interdepartmental agreement with one of				
	Engineering schools				
(C3-b)	University that has an institution-wide agreement				
(C4)	Other universities that are deemed necessary by the				
	Engineering schools				

2. Start studying abroad

June to November 2024

- 1) For the application and dispatch period, please refer to the "Annual Schedule of the International Exchange Program" posted on the Call for Applications page of this program (Tokyo Tech website).
- 2) As for start date in April and May, application is acceptable only for universities that meet the nomination deadline.
 - Please check the nomination deadline for the partner university on the "Requirements of partner universities" posted on the Call for Applications page of this program (Tokyo Tech website).
- 3) Study abroad period is about 2 to 3 months (timing and duration to be determined by the host laboratory) *Applicants for less than 60 days are not eligible.
- 4) Requirements may differ depending on the partner university. Please refer to the link in " Partner university Requirement Sheet" posted on the Call for Applications page of this program (Tokyo Tech website).

3. Financial Support for Outbound Students

Scholarship is provided based on the results of the screening.

- 1) No payment will be made for research equipment/facilities use or registration fees, if any.
- 2) Application fees and expenses for visa acquisition are NOT provided.
- 3) In the case of Japanese government (MEXT) scholarship students, only the round-trip travel expense (airfare) is provided. Also, please note that there might be a possibility for those who participate in this program to lose their eligibility to receive the MEXT scholarship not only during the stay abroad but also after coming back to Tokyo Tech. Please confirm the detailed and latest information about this with Student Support Division. gak.sei@jim.titech.ac.jp
- 4) If other scholarships or financial aids are provided to students by Tokyo Tech, the amount of the financial support under this program will be adjusted.

4. Prospective Applicants:

- 1) In principle, students who are enrolled in a master's or doctoral degree program at the Engineering Schools (School of Engineering, School of Materials and Chemical Technology, and School of Environment and Society) as of April 1, 2024.
 - ♦ Note 1: Working adult students are not eligible.
 - ♦ Note 2: Undergraduate 4th students who have passed the exam for a master's degree program at the Engineering Schools are also eligible.
 - ♦ Note 3: Applications for the following purposes are not eligible.
 - Joint research between the host lab and Tokyo Tech
 - Research relating to students' theses or doctoral dissertations
 - Study abroad with the main purpose of earning lecture credits
 - Study abroad to fulfill the requirements for Tokyo Tech projects
 - Doctoral students who wish to earn credits for off-campus
 - ♦ Note 4: Students who graduate early in 3.5 years will be allowed to apply if they are approved by the rules set by each school and department.
 - Note 5: Applicants planning to study in their home county are NOT eligible.
- 2) A grade point average of 2.30 or higher in the previous year at the time of selection (see Note 1 in the following page)
- 3) TOEFL (iBT) score of 70 or TOEIC score of 650 or above. However, if there is a special reason, such as fluency in the local language, a letter of explanation (any form) must be submitted with the application.
- 4) Meet the all requirements including language and academic scores, of the program and the host university.

5. Deadline

Sunday, December 10, 2023

Note: Applications that arrive after this deadline will not be processed, regardless of reason.

6. Interview:

Afternoon on Wednesday, December 20, 2023

- 1) In case of a large number of applicants, a preliminary screening will be conducted based on the submitted application forms.
- 2) Details will be provided only to those who pass the document screening and no later than the day before the interview.
- 3) In case of legitimate reasons, a petition for a preferred interview time slot will be accepted only at the

- time of application.
- 4) In principle no special measures shall be taken for reasons such as external factors, so please apply with time to spare and under the thorough management of your physical condition.

7. How to Apply and Required Documents

Application Data Entry Form (T2Form) URL: https://www.t2form.titech.ac.jp/sv/522184?lang=ja Please access the application form from the link above and enter the required information.

<Documents to be uploaded to the Data Entry Form (upload to the designated areas)>

- ① Application Form (Form 1): Reasons for application, research plan, etc.
- Recommendation Letter (Form 2) written by Academic Supervisor
 *Be sure to use the designated forms (Forms 1 and 2) for (1) and (2) above. The forms can be downloaded from the "Call for Applications" page of this program.
- ③ Resume in English (optional format)
- 4 A copy of your English language test scores
 - Note1: Some universities may have their own English language requirements, such as TOEFL iBT® or IELTS scores. The applicant must check with the university in which you wish to enroll.
 - ♦ Note2: For (C1) and (C2), please refer to the acceptance requirements of each university.
 - ♦ Note3: Applicants may submit a new, better score report to the interviewers in person during the interview.
- - ♦ Note1: The transcript must include your academic record of the previous year.
 - ♦ Note2: Students in their first year of a master's degree program must attach their undergraduate final grade academic transcripts.
 - ♦ Note3: If you were enrolled at another university in the previous year, please request a copy of the transcript well in advance.
- 6 Statement of Reason for those below. *Free format
 - A) C3-b applicants who cannot apply for or was rejected by the university-wide program conducted by International Student Exchange Division (written by applicants)
 - B) All (C4) applicants (written by applicants, and by their Chair of Department, Head of Graduate Studies or academic supervisor)
- (7) A copy of the email that shows the applicant get acceptance consent from a host professor
 - A) All (C3) and (C4) applicants
 - B) Some (C2) applicants who already have the consent above for any reason
 - ♦ Note1: Incomplete applications and applications received after the deadline will not be accepted under any circumstances.
 - ♦ Note2: Submitted documents will not be returned.
 - ♦ Note3: Your email address and other information may be provided to international-related department within Tokyo Tech.
 - ♦ Note4: In addition to the language requirement, if there are other materials designated by each university, please submit them by the date and time specified by the International Exchange Team after you have been selected for dispatch.

8. Notification of Results

Applicants and their academic advisors will be notified of the selection results approximately one week after the selection interviews.

We will not be able to respond to inquiries regarding individual selection results.

9. Inquiry

International Exchange Team, Engineering Schools (Main Bldg., Floor 2, Rm 256)
Mailbox: H-106 TEL: 3859 e-mail: ko.intl@jim.titech.ac.jp

Note1: Grade Requirements:

Students applying for categories (C1), (C2), (C3), and (C4) must enter their GPA for the previous academic year in Date Entry Form. GPA must be calculated based on the calculation method below and applicants must have a GPA of 2.3 or higher.

How to calculate your Grade Point Average according to the JASSO evaluation scale

Grade Conversion Table

			Grade					
Four-level (Type 1)	grading	scale	I	Excellent	Good	Fair	Fail	
Four-level (Type 2)	grading	scale	1	A	В	С	F	
Four-level (Type 3)	grading	scale	_	100–80	79–70	69–60	59 or lower	
Five-level (Type 4)	grading	scale	100–90	89–80	79–70	69–60	59 or lower	
Five-level (Type 5)	grading	scale	S	Α	В	С	F	
Five-level (Type 6)	grading	scale	А	В	С	D	F	
	/aluation F (GEP)	Point	3	3	2	1	0	

Note2: Partner universities requirements

- Note1: Please refer to the link in "Partner university Requirement Sheet" posted on the Call for Applications page of this program (Tokyo Tech website).
- ♦ Note2: New requirements might be added. Please check out the latest information accordingly on the web

Note3: The Report Session

Students accepted into this program are required to make a presentation at the study abroad debriefing session after returning.

Note4: International Research Program

In principle, students accepted into this program are required to take the International Research Program and receive credit (4 credits).

It is possible to take courses related to study abroad in each department and course, but in such cases, the credit will not be granted in duplicate with this course.

Note5: Other scholarships

When (C1), (C2) applicants will also apply to other scholarships for studying abroad, applicants should check the requirements both this program and other scholarships before applying.

Tokyo-Tech HP Top > Current Students> Scholarships for Study Abroad

Note6: FAQ

Please carefully read our FAQs before applying on the Call for Applications page of this program.

Note7: the Call for Applications page of this program (Tokyo Tech website)